g	GE Energy	Functional Testing Specification
	Parts & Repair Services Louisville, KY	LOU-GENEVA-IS200VAOC

Test Procedure for IS200VAOC cards tested on the GENEVA Test System

REV.	DESCRIPTION	SIGNATURE	REV. DATE
Α	Initial release	R. Duvall	05/21/03
В	Transferred procedure from a general group to a specific single document. Also added asset numbers to section 5.	D. Johnson	9/24/2010
С			

© COPYRIGHT GENERAL ELECTRIC COMPANY

Hard copies are uncontrolled and are for reference only.

PROPRIETARY INFORMATION – THIS DOCUMENT CONTAINS PROPRIETARY INFORMATION OF GENERAL ELECTRIC COMPANY AND MAY NOT BE USED OR DISCLOSED TO OTHERS, EXCEPT WITH THE WRITTEN PERMISSION OF GENERAL ELECTRIC COMPANY.

PREPARED BY Darren Johnson	REVIEWED BY	REVIEWED BY	Charlie Wade
DATE 09/24/2010	DATE	DATE	DATE 9/24/2010

LOU-GENEVA-IS200VAOC
Rev B

GE Energy
Part & Repair Services
Louisville, KY

Page 2 of 3

Functional test procedure for IS200VAOC cards tested on the GENRAD® GENEVA system

1. SCOPE

1.1 This is a functional testing procedure for various circuit boards.

2. STANDARDS OF QUALITY

2.1 Refer to the current revision of the IPC-A-610 standard for workmanship standards.

3. APPLICABLE DOCUMENTS

- **3.1** The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
 - **3.1.1** Check the board's electronic folder for more information.

4. ENGINEERING REQUIREMENTS

- 4.1 Equipment Cleaning
 - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to site specific SRA's for cleaning guidelines.
- 4.2 Equipment Inspection
 - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
 - 4.2.1.1 Wires broken or cracked
 - 4.2.1.2 Terminal strips / connectors broken or cracked
 - **4.2.1.3** Loose wires
 - 4.2.1.4 Components visually damaged
 - 4.2.1.5 Capacitors leaking
 - 4.2.1.6 Solder joints damaged or cold
 - 4.2.1.7 Circuit board burned or de-laminated
 - 4.2.1.8 Printed wire runs burned or damaged

5. EQUIPMENT REQUIRED

5.1 The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1	H188912	GENRAD Geneva Test System
1	H188746	VAOC Functional Test Fixture

g

LOU-GENEVA-IS200VAOC Rev B

GE Energy Part & Repair Services Louisville, KY Page 3 of 3

6. Testing Process

- 6.1 Setup
 - **6.1.1** Install fixture H188746 onto Geneva test System.
 - **6.1.2** Install UUT into test fixture.
- 6.2 Testing Procedure
 - **6.2.1** Load appropriate test program and follow instructions on screen.
- 6.3 ***TEST COMPLETE ***

7. Notes

- 7.1 Changes to the electronic test file are located in the following directory on the local hard drive; C:\Genevalnfo\Geneva\Geneva Test Fixture Notes.
 - **7.1.1** These changes have been backed up on CD.

8. Attachments

8.1 Picture of the Geneva Test System

